

PATENT
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of: Young-Hee MUN.

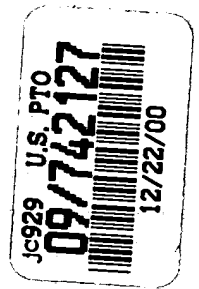
Serial No.: New Application

Group Art Unit: Not Yet Assigned

Filed: December 22, 2000

Examiner: Not Yet Assigned

For: METHOD OF TREATING SEMICONDUCTOR WAFER THERMALLY AND
SEMICONDUCTOR WAFER FABRICATED BY THE SAME.



#3 IDS
7-25-01
R. H. H. H.

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner of Patents
Washington, DC 20231

December 22, 2000

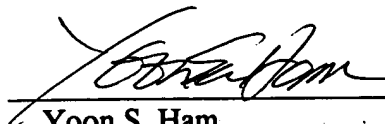
Sir:

As a means of complying with the duty of disclosure under 37 CFR §1.56, and in accordance with 37 CFR §§1.97 and 1.98, Applicant(s), through the undersigned attorney, submits this Information Disclosure Statement. The patents, publications or other information submitted herewith are listed on the attached Form PTO-1449 and copies are attached.

In accordance with 37 CFR §1.97(b)(1) or (2), this Information Disclosure Statement is being filed either within three months of the filing date of the above-identified application, or within three months of the date of entry into the national stage of the above-identified application as set forth in 37 CFR §1.491. Accordingly, no fee is required.

Respectfully submitted,
JACOBSON, PRICE, HOLMAN & STERN, PLLC

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